CMOS LDO Regulators for Portable Equipments

1ch 500mA CMOS LDO Regulators

BUxxSD5 series

●General Description

BUxxSD5 series are high-performance CMOS LDO regulators with output current ability of up to 500mA.
These devices have excellent noise and load response characteristics despite of its low circuit current consumption of 33μA. They are most appropriate for various applications such as power supplies for logic IC, RF, and camera modules.

●Features

- High Output Voltage Accuracy: ±2.0%
  (In all recommended conditions)
- High Ripple Rejection: TYP;68dB(f=1KHz)
- Compatible with small ceramic capacitor
  (Cin=Cout=0.47 μF, min)
- Low Current Consumption: 33 μA
- Output Voltage ON/OFF control
- Built-in Over Current Protection Circuit (OCP)
- Built-in Thermal Shutdown Circuit (TSD)
- Package SSOP5 is similar to SOT23-5(JEDEC)

●Applications

- Portable devices
- Camera modules
- Other electronic devices using microcontrollers or logic circuits

●Key Specifications

- Input Power Supply Voltage Range: 1.7V to 6.0V
- Output Current Range: 0 to 500mA
- Operating Temperature Range: -40℃ to +105℃
- Output Voltage Lineup: 1.8V, 3.3V
- Output Voltage Accuracy: ±2.0%
- Circuit Current: 33μA(Typ.)
- Standby Current: 0μA (Typ.)

●Package

	W(Typ) x D(Typ) x H(Max)
SSOP5	2.90mm x 2.80mm x 1.25mm



●Typical Application Circuit

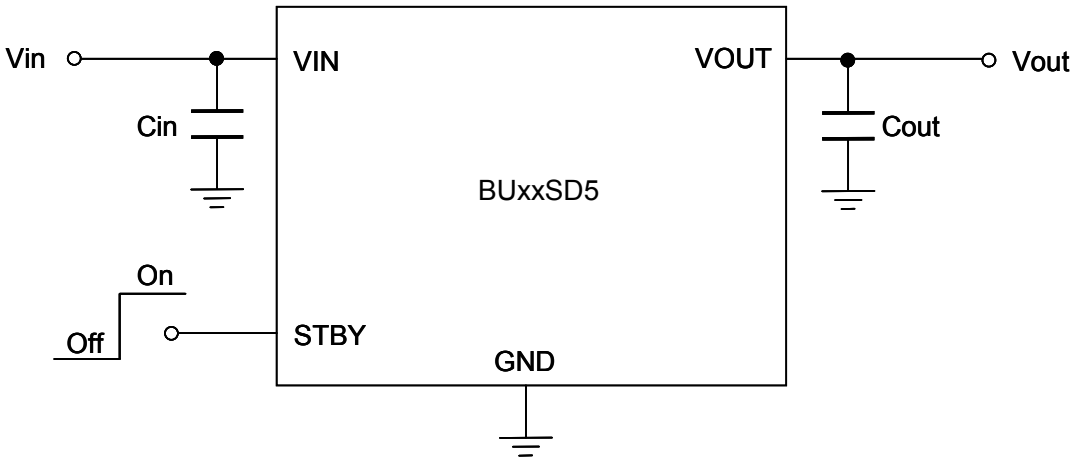
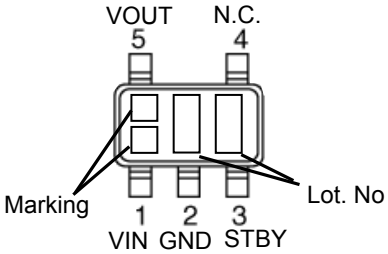


Figure 1. Typical Application Circuit

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●Pin Configuration



●Pin Description

Pin No.	Symbol	Function
1	VIN	Input Pin
2	GND	GND Pin
3	STBY	Output Control Pin (High:ON, Low:OFF)
4	N.C.	No Connect
5	VOUT	Output Pin

●Block Diagram

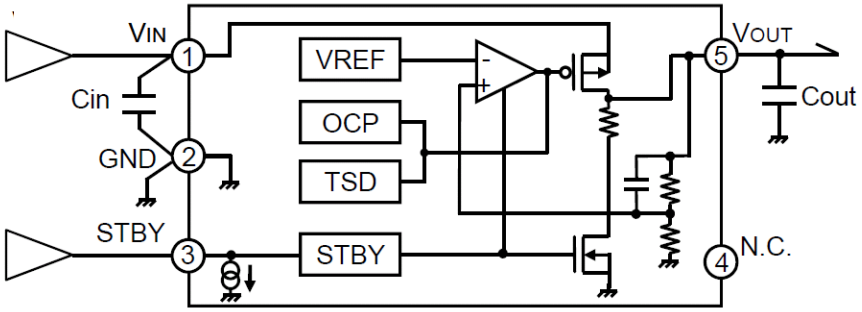


Figure 2. Block diagram

Cin(min)=0.47μF (Ceramic capacitor)
Cout(min)=0.47μF (Ceramic capatitor)

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●Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Maximum Power Supply Voltage Range	VMAX	-0.3 to +6.5	V
Power Dissipation	Pd	540(*1)	mW
Maximum Junction Temperature	Tjmax	+125	℃
Operating Temperature Range	Topr	-40 to +105	℃
Storage Temperature Range	Tstg	-55 to +125	℃

(*1) Derate by 5.4mW/℃ when operating above Ta=25℃.(When mounted on a board 70mm × 70mm × 1.6mm glass-epoxy board, two layer)

●Recommended Operating Ratings

Parameter	Symbol	Rating	Unit
Input Power Supply Voltage Range	VIN	1.7 to 6.0	V
Maximum Output Current	IMAX	500	mA

●Recommended Operating Conditions

Parameter	Symbol	Limit			Unit	Conditions
		Min	Typ	Max		
Input capacitor	Cin	0.47(*2)	1.0	—	μF	A ceramic capacitor is recommended.
Output capacitor	Cout	0.47(*2)	1.0	—	μF	A ceramic capacitor is recommended.

(*2) Set the value of the capacitor so that it does not fall below the minimum value. Take into consideration the temperature characteristics, DC bias characteristics, and degradation with time.

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●**Electrical Characteristics**

(Unless otherwise noted,Ta=-40 to 105℃,V_{IN}=V_{OUT}+1.0V(*3),V_{STBY}=1.5V,Cin=1μF,Cout=1μF,Typical value apply for Ta=25℃.)

PARAMETER		Symbol	Limit			Unit	Conditions
			MIN.	TYP.	MAX.		
Output Voltage		V_{OUT}	V_{OUT} ×0.98	V_{OUT}	V_{OUT} ×1.02	V	I_{OUT}=1mA, V_{OUT}≧2.5V, V_{IN}=V_{OUT}+0.5 to 6.0V (*4) V_{OUT}＜2.5V, V_{IN}=3.0 to 6.0V (*4)
Line Regulation1		V_{DLI1}	-	4	10	mV	I_{OUT}=10mA V_{OUT}≦2.5V, V_{IN}=3.0 to 6.0V
Line Regulation2		V_{DLI2}		6	15	mV	I_{OUT}=10mA V_{OUT}＞2.5V, V_{IN}=V_{OUT}+0.5 to 6.0V
Load Regulation1		V_{DLO1}	-	0.5	5	mV	I_{OUT}=1 to 100mA
Load Regulation2		V_{DLO2}	-	2.5	25	mV	I_{OUT}=1 to 500mA
Dropout Voltage		V_{DROP}	-	400	700	mV	1.0V≦V_{OUT}＜1.2V, I_{OUT}=100mA
			-	280	550	mV	1.2V≦V_{OUT}＜1.5V, I_{OUT}=100mA
			-	180	370	mV	1.5V≦V_{OUT}＜1.7V, I_{OUT}=100mA
			-	150	290	mV	1.7V≦V_{OUT}＜2.1V, I_{OUT}=100mA
			-	110	220	mV	2.1V≦V_{OUT}＜2.5V, I_{OUT}=100mA
			-	100	180	mV	2.5V≦V_{OUT}＜2.8V, I_{OUT}=100mA
			-	85	150	mV	2.8V≦V_{OUT}, I_{OUT}=100mA
Limit Current		I_{LMAX}	-	800	-	mA	Vo=V_{OUT}×0.98, Ta=25℃
Short Current		I_{SHORT}	-	180	-	mA	Vo=0V, Ta=25℃
Circuit Current		I_{GND}	-	33	80	μA	I_{OUT}=0mA
Circuit Current (STBY)		I_{CCST}	-	-	2.0	μA	V_{STBY}=0V
Ripple Rejection Ratio		R.R.	-	68	-	dB	V_{RR}=-20dBv,f_{RR}=1kHz,I_{OUT}=10mA Ta=25℃
Load Transient Response		V_{LOT}	-	±65	-	mV	I_{OUT}=1mA to 150mA,Trise=Tfall=1μs, V_{IN}=V_{OUT}+1.0V,Ta=25℃
Output Noise Voltage		V_{NOIS}	-	30	-	μVrms	Bandwidth 10 to 100kHz, Ta=25℃
Discharge Resistor		R_{DSC}	20	50	80	Ω	V_{IN}=4.0V, V_{STBY}=0V, V_{OUT}=4.0V, Ta=25℃
STBY Control Voltage	ON	V_{STBH}	1.1	-	V_{IN}	V	Ta=25℃
	OFF	V_{STBL}	-0.2	-	0.5	V	
STBY Pin Current		I_{STBY}	-	-	4.0	μA	

(*3) V_{IN}=3.5V for V_{OUT}＜2.5V.

(*4) Operating Conditions are limited by Pd.

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●**Reference data BU18SD5WG (Unless otherwise specified, Ta=25℃.)**

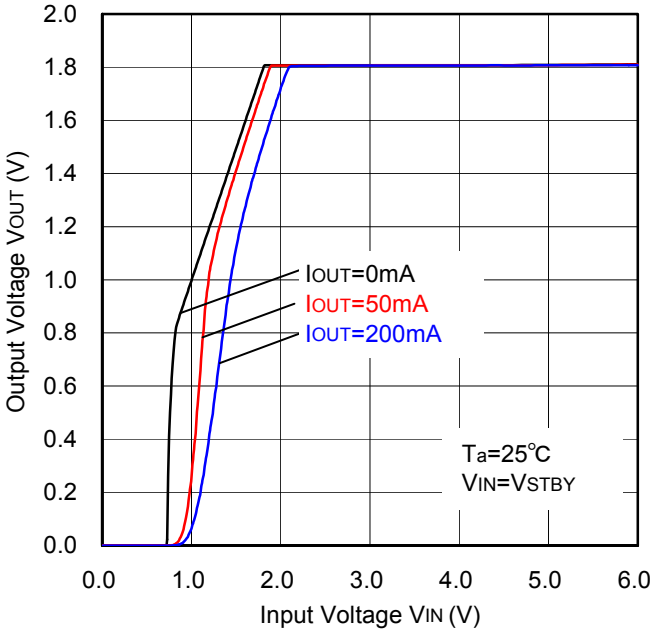


Figure 3. Output Voltage vs. Input Voltage

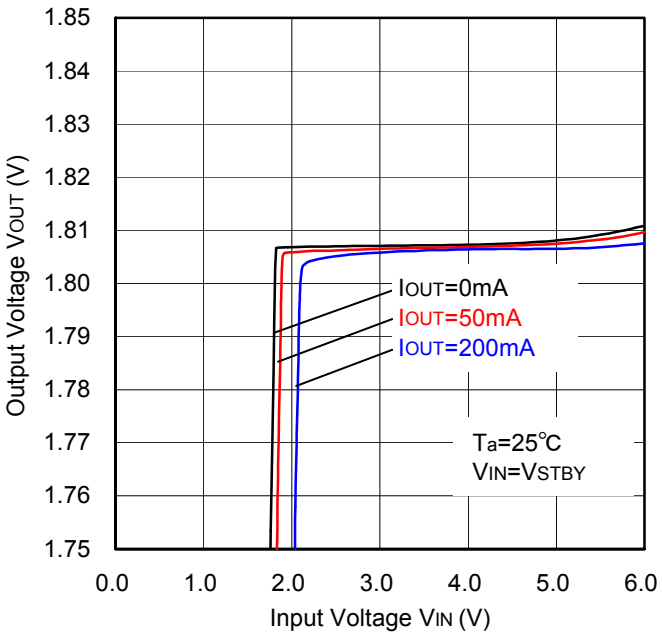


Figure 4. Line Regulation

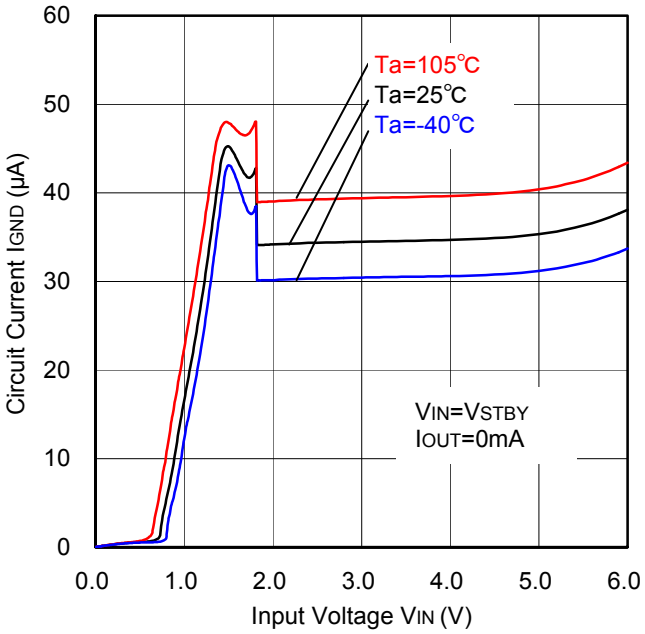


Figure 5. Circuit Current vs. Input Voltage

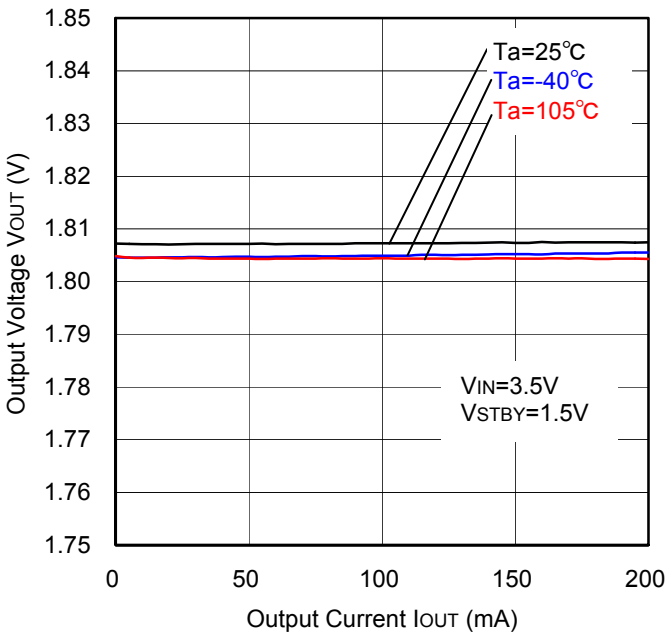


Figure 6. Load Regulation

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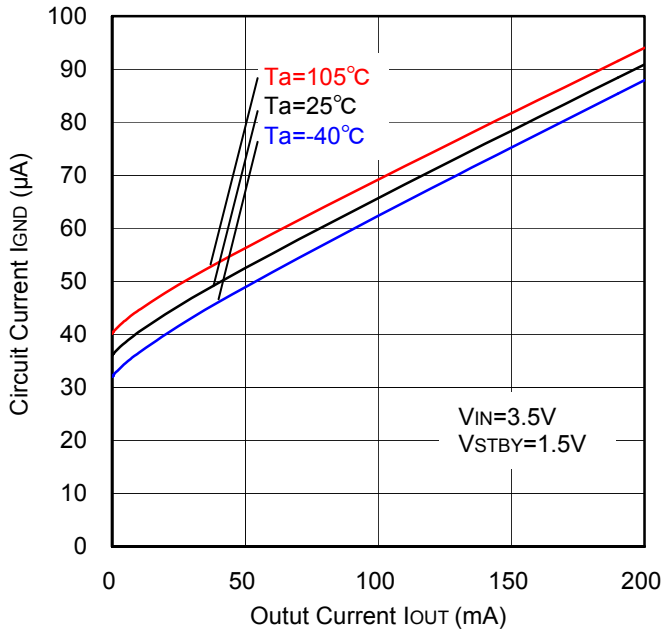


Figure 7. Circuit Current vs. Output Current

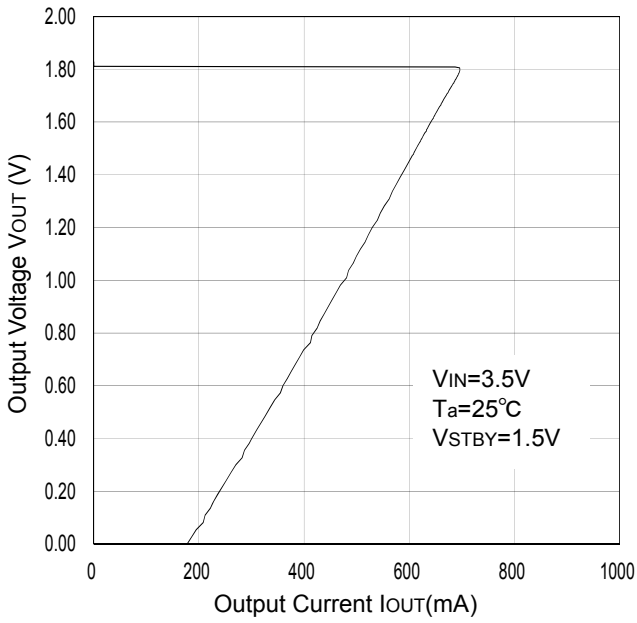


Figure 8. OCP Threshold

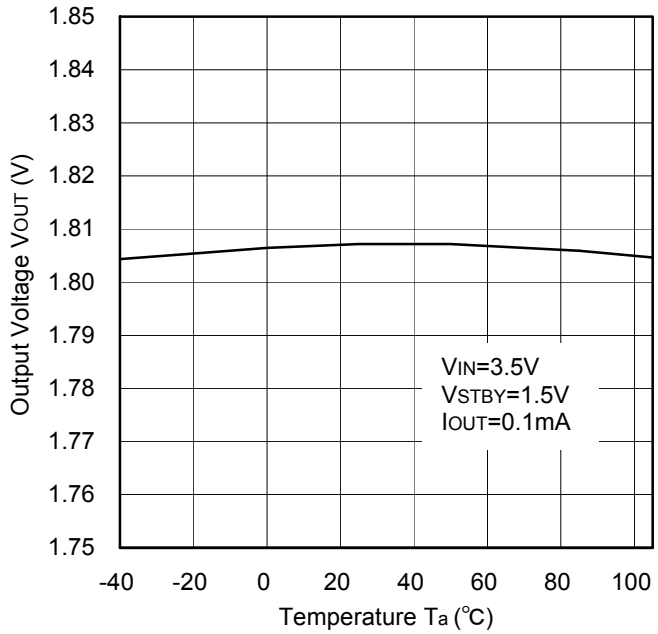


Figure 9. Output Voltage vs. Temperature

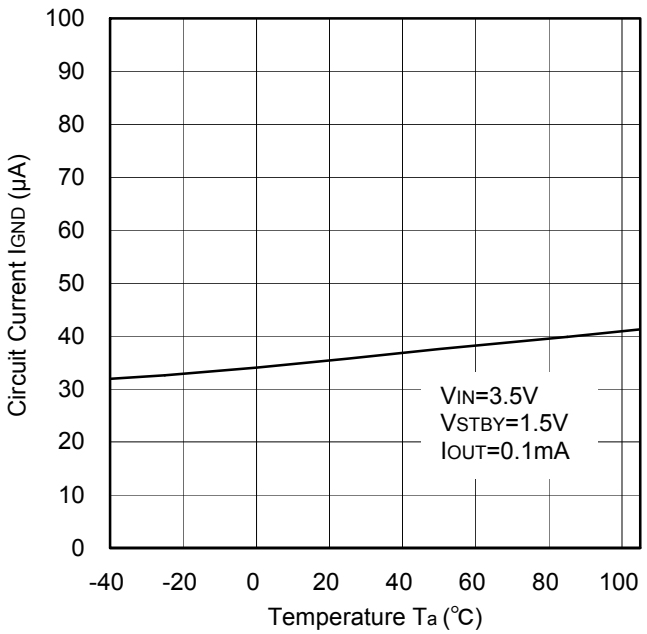


Figure 10. Circuit Current vs. Temperature

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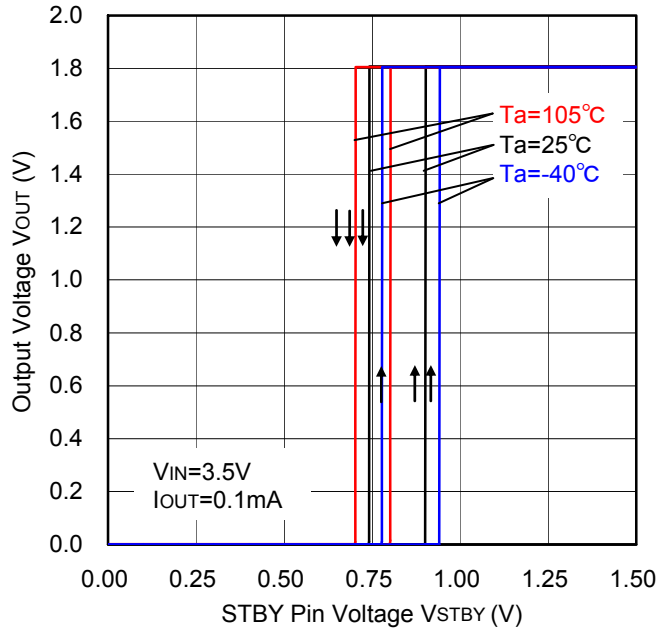


Figure 11. STBY Threshold

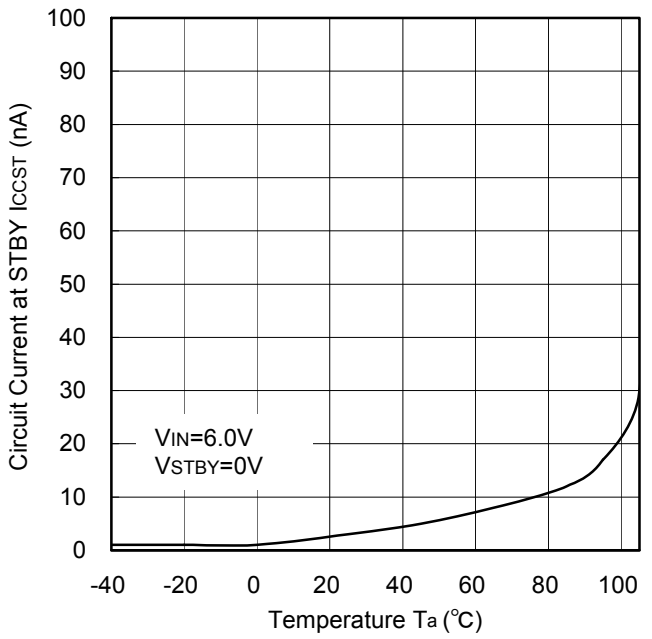


Figure 12. Circuit Current (at STBY) vs. Temperature

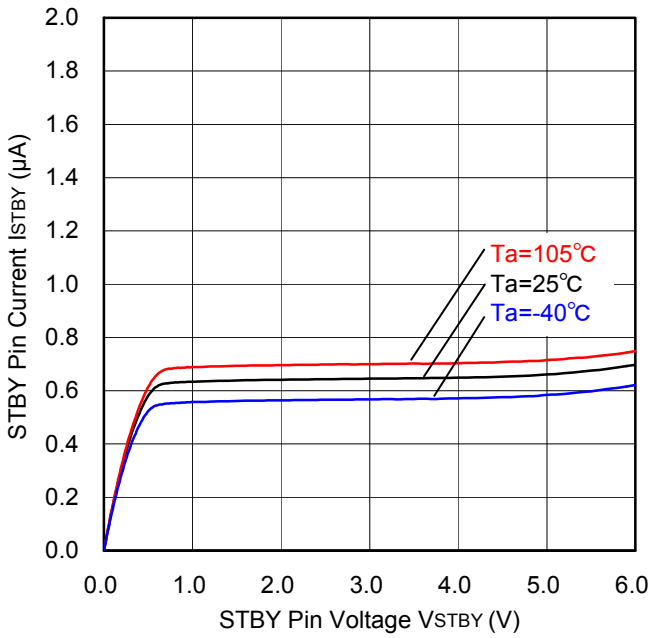


Figure 13. STBY Pin Current vs. STBY Pin Voltage

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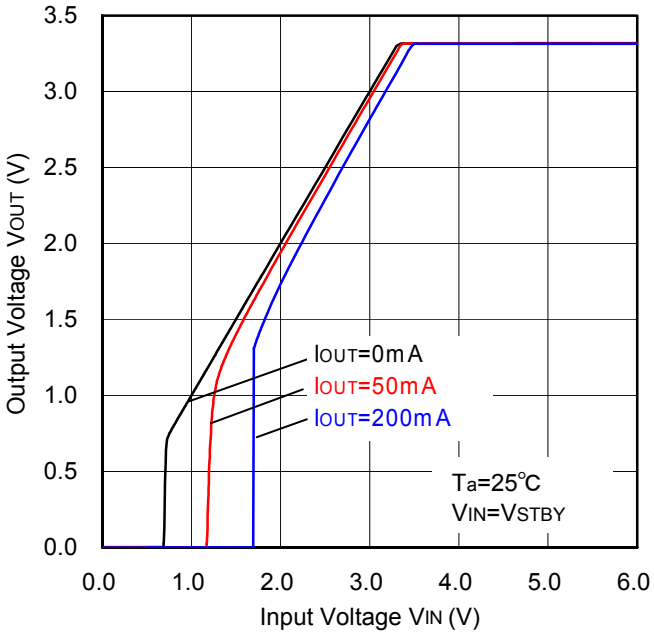


Figure 14. Output Voltage vs. Input Voltage

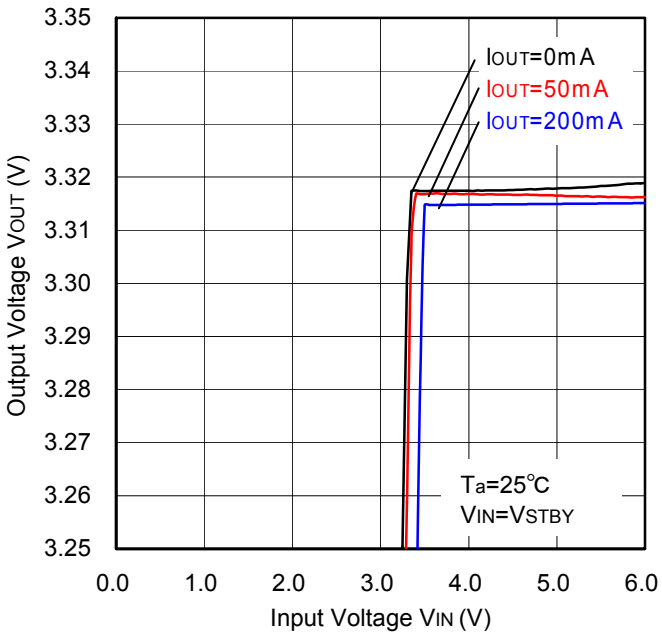


Figure 15. Line Regulation

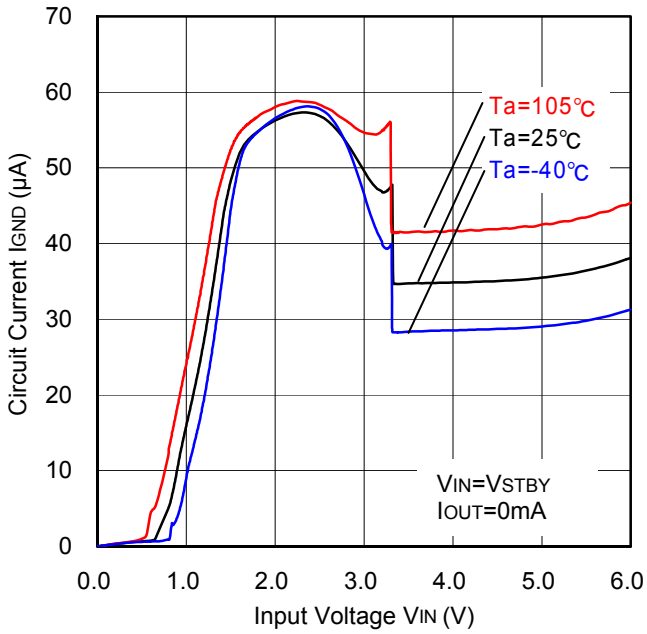


Figure 16. Circuit Current vs. Input Voltage

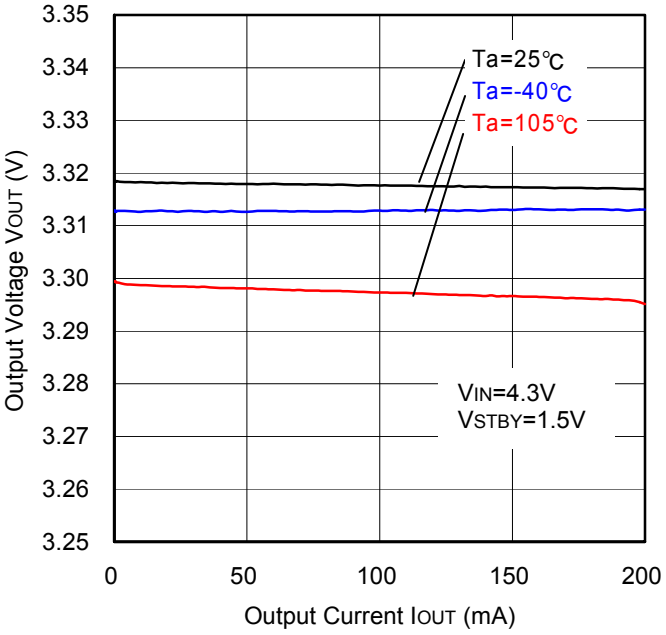


Figure 17. Load Regulation

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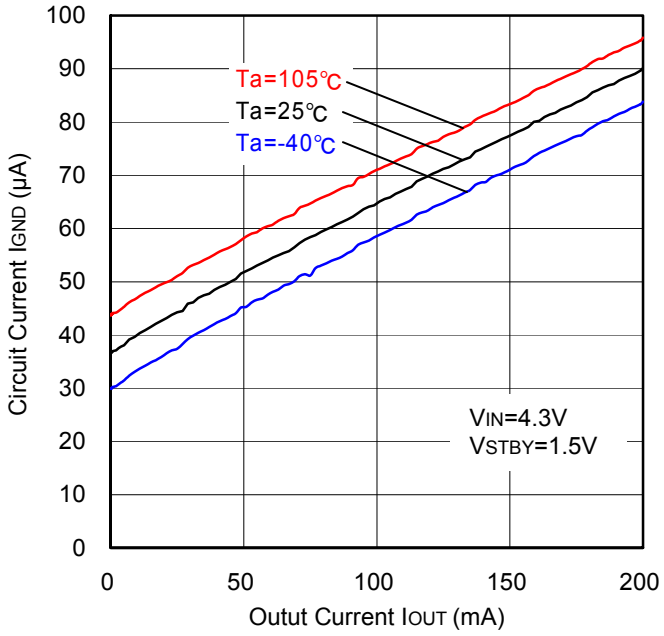


Figure 18. Circuit Current vs. Output Current

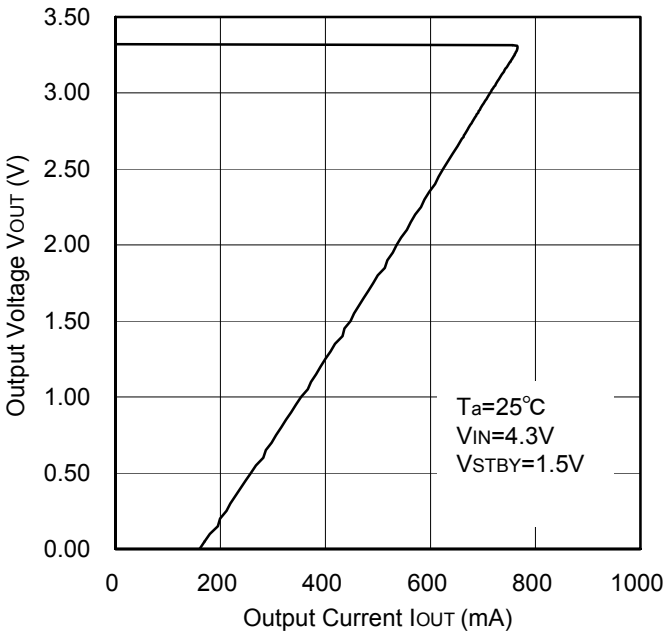


Figure 19. OCP Threshold

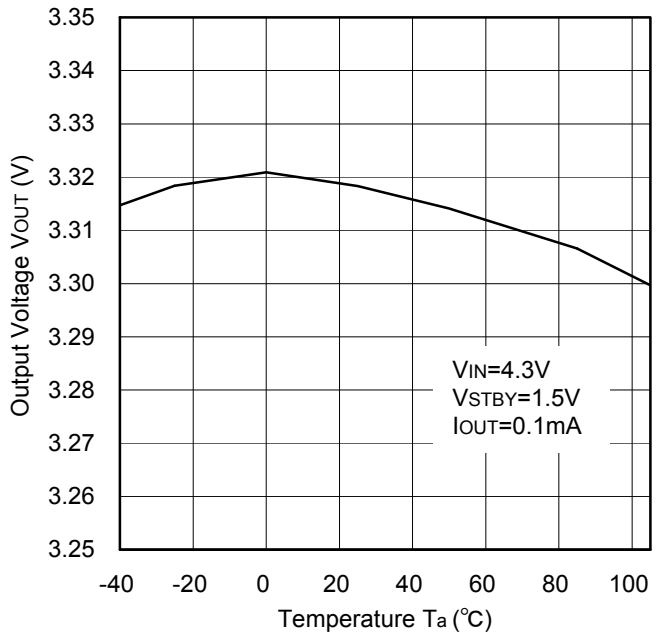


Figure 20. Output Voltage vs. Temperature

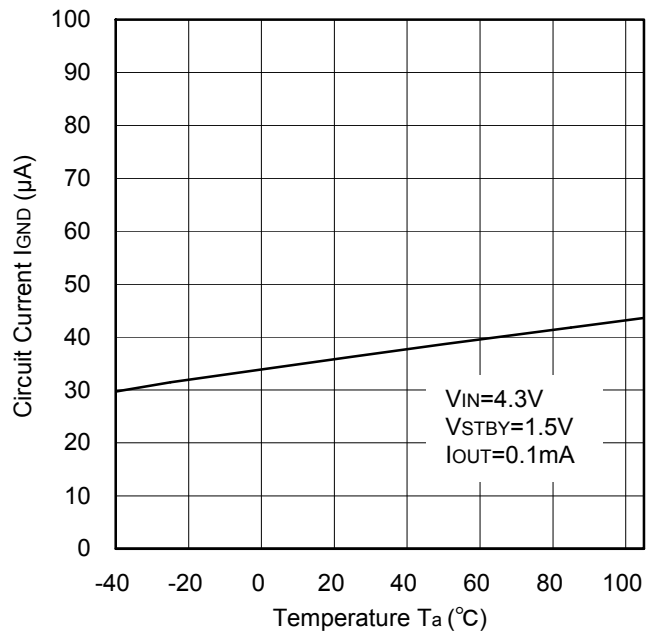


Figure 21. Circuit Current vs. Temperature

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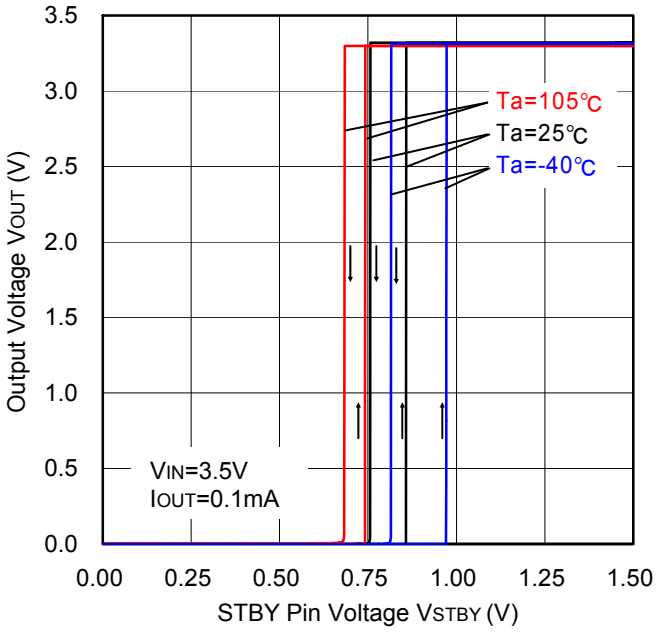


Figure 22. STBY Threshold

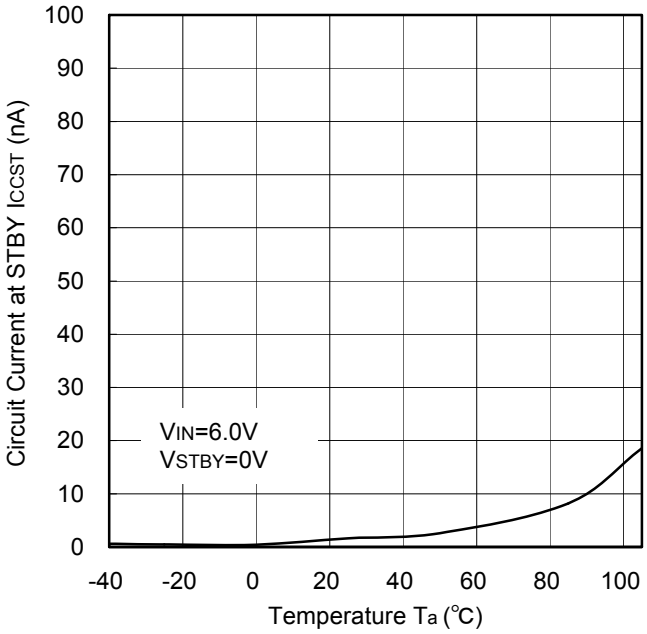


Figure 23. Circuit Current (at STBY) vs. Temperature

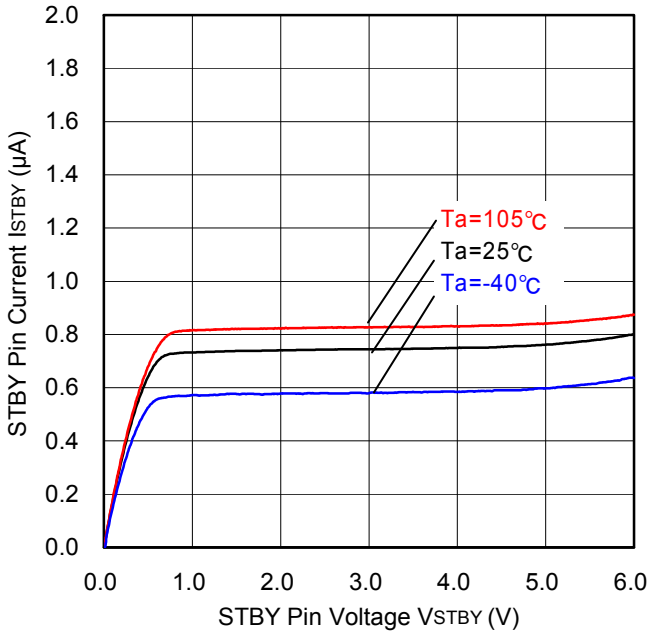


Figure 24. STBY Pin Current vs. STBY Pin Voltage

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●Input/Output Capacitor

It is recommended that an input capacitor is placed near pins between the VCC pin and GND as well as an output capacitor between the output pin and GND. The input is valid when the power supply impedance is high or when the PCB trace has significant length. For the output capacitor, the greater the capacitance, the more stable the output will be depending on the load and line voltage variations. However, please check the actual functionality of this capacitor by mounting it on a board for the actual application. Ceramic capacitors usually have different, thermal and equivalent series resistance characteristics, and may degrade gradually over continued use.
For additional details, please check with the manufacturer, and select the best ceramic capacitor for your application

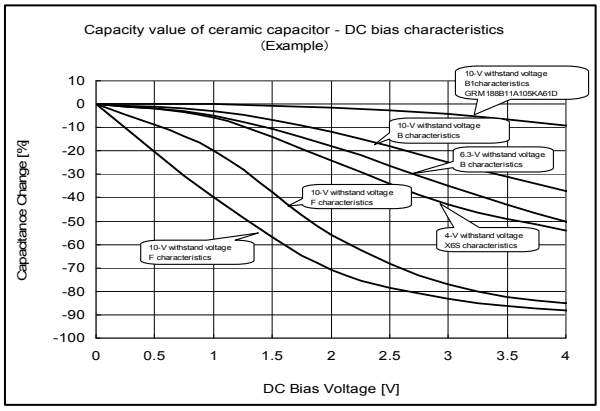


Figure 25. Capacity-bias characteristics (Example)

●Equivalent Series Resistance (ESR) of a Ceramic Capacitor

Capacitors generally have ESR (equivalent series resistance) and it operates stably in the ESR-IOUT area of the output capacitor shown on the right. Since ceramic capacitors, tantalum capacitors, electrolytic capacitors, etc. generally have different ESR, please check the ESR of the capacitor to be used and use it within the stability area range shown in the right graph for evaluation of the actual application.

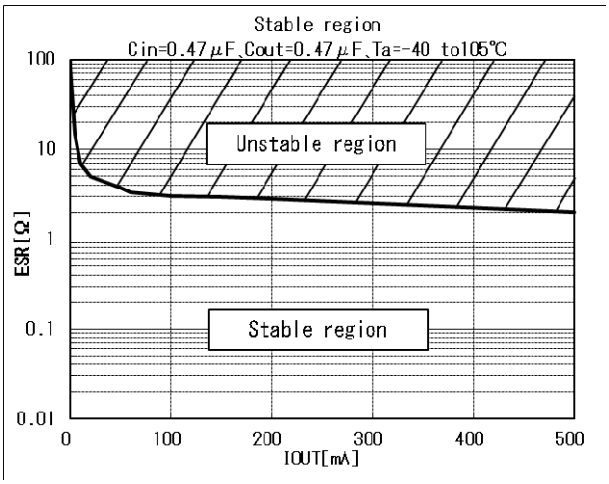


Figure 26. Stability area characteristics

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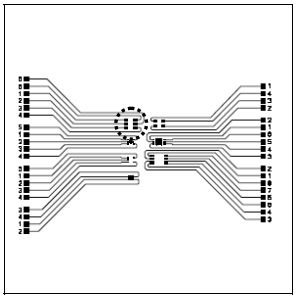
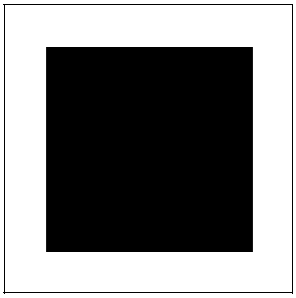
●Power Dissipation (Pd)

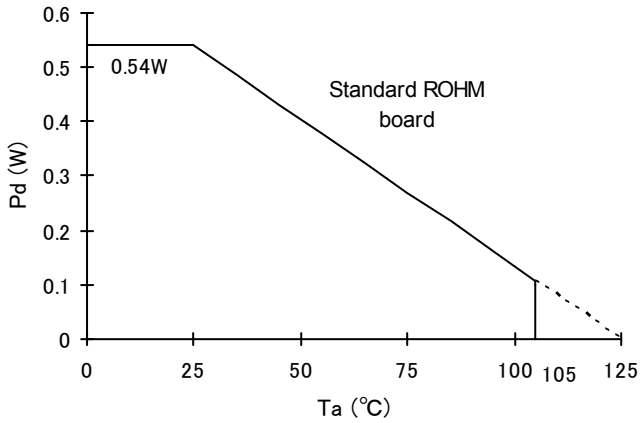
As for power dissipation, an estimate of heat reduction characteristics and internal power consumption of IC are shown, so please use these for reference. Since power dissipation changes substantially depending on the implementation conditions (board size, board thickness, metal wiring rate, number of layers and through holes, etc.), it is recommended to measure Pd on a set board. Exceeding the power dissipation of IC may lead to deterioration of the original IC performance, such as causing the operation of the thermal shutdown circuit or reduction in current capability. Therefore, be sure to prepare sufficient margin within power dissipation for usage.

Calculation of the maximum internal power consumption of IC (PMAX)

$P_{MAX}=(V_{IN}-V_{OUT})\times I_{OAVE}$ Where : V_{IN}=Input voltage V_{OUT}= Output voltage I_{OAVE}: Average output current)

○Measurement conditions

		Standard ROHM Board
Layout of Board for Measurement IC Implementation Position		 Top Layer (Top View)  Bottom Layer (Top View)
Measurement State		With board implemented (Wind speed 0 m/s)
Board Material		Glass epoxy resin (Double-side board)
Board Size		70 mm x 70 mm x 1.6 mm
Wiring Rate	Top layer	Metal (GND) wiring rate: Approx. 0%
	Bottom layer	Metal (GND) wiring rate: Approx. 50%
Through Hole		Diameter 0.5mm x 6 holes
Power Dissipation		0.54W
Thermal Resistance		θja=185.2℃/W



* Please design the margin so that PMAX is less than Pd (P_{MAX}<Pd) within the usage temperature range

Figure 27. SSOP5 Power dissipation heat reduction characteristics (Reference)

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●I/O Equivalence Circuits

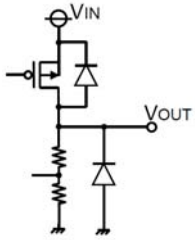
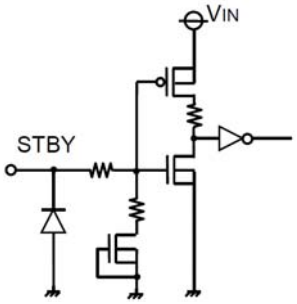
5pin (VOUT)	2pin (GND)	3pin (STBY)	1pin (VIN)
			

Figure 28. Input / Output equivalent circuit

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●Operational Notes

1) Absolute maximum ratings

This product is produced with strict quality control, however it may be destroyed if operated beyond its absolute maximum ratings. In addition, it is impossible to predict all destructive situations such as short-circuit modes, open circuit modes, etc. Therefore, it is important to consider circuit protection measures, like adding a fuse, in case the IC is operated in a special mode exceeding the absolute maximum ratings.

2) GND Potential

GND potential must be the lowest potential of all pins of the IC at all operating conditions. Ensure that no pins are at a voltage below the ground pin at any time, even during transient condition.

3) Setting of Heat

Carry out the heat design that have adequate margin considering Pd of actual working states.

4) Pin Short and Mistake Fitting

When mounting the IC on the PCB, pay attention to the orientation of the IC. If there is mistake in the placement, the IC may be burned up.

5) Actions in Strong Magnetic Field

Using the IC within a strong magnetic field may cause the IC to malfunction.

6) Mutual Impedance

Use short and wide wiring tracks for the power supply and ground to keep the mutual impedance as small as possible. Use a capacitor to keep ripple to a minimum.

7) STBY Pin Voltage

To enable standby mode for all channels, set the STBY pin to 0.5 V or less, and for normal operation, to 1.1 V or more. Setting STBY to a voltage between 0.5 and 1.1 V may cause malfunction and should be avoided. Keep transition time between high and low (or vice versa) to a minimum.

Additionally, if STBY is shorted to VIN, the IC will switch to standby mode and disable the output discharge circuit, causing a temporary voltage to remain on the output pin. If the IC is switched on again while this voltage is present, overshoot may occur on the output. Therefore, in applications where these pins are shorted, the output should always be completely discharged before turning the IC on.

8) Over Current Protection Circuit

Over current and short circuit protection is built-in at the output, and IC destruction is prevented at the time of load short circuit. These protection circuits are effective in the destructive prevention by sudden accidents, please avoid applications to where the over current protection circuit operates continuously.

9) Thermal Shutdown

This IC has Thermal Shutdown Circuit (TSD Circuit). When the temperature of IC Chip is higher than 175℃, the output is turned off by TSD Circuit. TSD Circuit is only designed for protecting IC from thermal over load. Therefore it is not recommended that you design application where TSD will work in normal condition.

10) Actions under Strong light

A strong light like a halogen lamp may be caused malfunction. In our testing, fluorescence light and white LED causes little effects for the IC, but infrared light causes strong effects on the IC. The IC should be shielded from light like sunrays or halogen lamps.

11) Output capacitor

To prevent oscillation at output, it is recommended that the IC be operated at the stable region shown in Figure 26. It operates at the capacitance of more than 0.47μF. As capacitance is larger, stability becomes more stable and characteristic of output load fluctuation is also improved.

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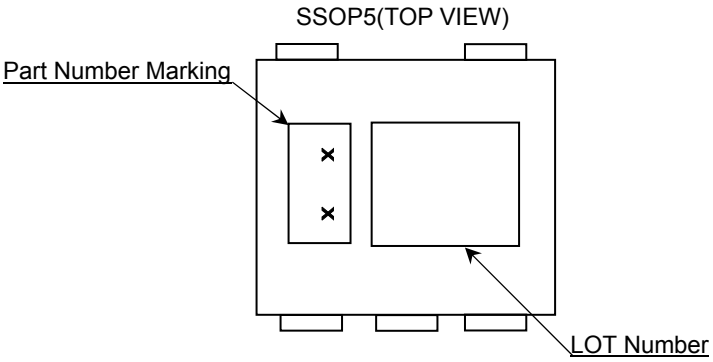
●**Ordering Information**

B U x x S D 5 W G - y y

ROHM Part No.	Output voltage xx=18:1.8V xx=33:3.3V	Series name SD5W:High-speed load response 500mA Low noise Shutdown SW	Package G: SSOP5	Packaging and forming specifications TR:Embossed tape and reel BU33SD5WG-TR(SSOP5) TL:Embossed tape and reel BU18SD5WG-TL(SSOP5)

●**Marking Diagram**

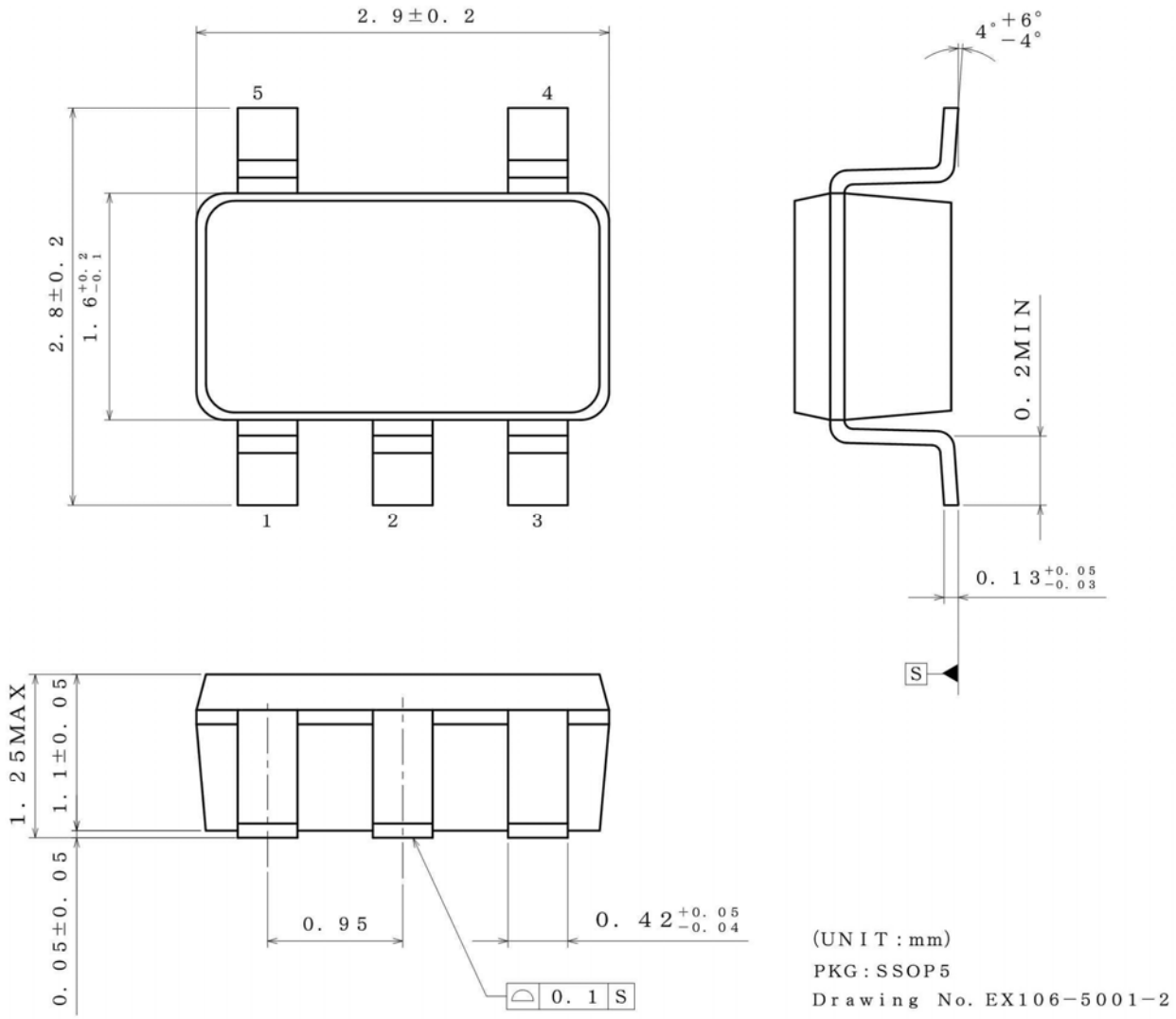
xx	Output Voltage	Marking
18	1.8V typ.	XY
33	3.3V typ.	RX



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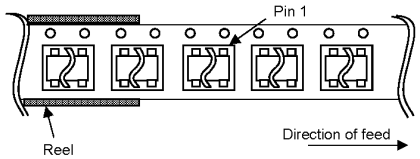
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Package Name	SSOP5



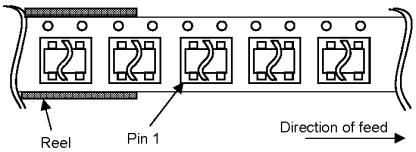
< Tape and Reel Information >

Tape	Embossed carrier tape
Quantity	3000pcs
Direction of feed	TR (The direction is the 1pin of product is at the upper right when you hold reel on the left hand and you pull out the tape on the right hand)



< Tape and Reel Information >

Tape	Embossed carrier tape
Quantity	3000pcs
Direction of feed	TL (The direction is the 1pin of product is at the lower left when you hold reel on the left hand and you pull out the tape on the right hand)



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●**Revision History**

Date	Revision	Changes
24.Dec.2013	001	New Release
24.Mar.2014	002	1) Moved the descriptions of Limit current and Short current from P11 to P4. 2) Added the description of Discharge resistor to P4.
31.May.2016	003	Lineup addition.(BU18SD5WG-TL). Added the evaluation data of BU18SD5WG Correction of errors(Annotation of P4 electrical characteristics etc.)

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1. Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASSⅡb	CLASSⅢ
CLASSⅣ		CLASSⅢ	

2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
   [a] Installation of protection circuits or other protective devices to improve system safety
   [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure

3. Our Products are designed and manufactured for use under standard conditions and not under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
   [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
   [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
   [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl_2, H_2S, NH_3, SO_2, and NO_2
   [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
   [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
   [f] Sealing or coating our Products with resin or other coating materials
   [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
   [h] Use of the Products in places subject to dew condensation

4. The Products are not subject to radiation-proof design.

5. Please verify and confirm characteristics of the final or mounted products in using the Products.

6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.

7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.

8. Confirm that operation temperature is within the specified range described in the product specification.

9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.

2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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Precautions Regarding Application Examples and External Circuits

1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.

2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of Ionizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
   - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
   - [b] the temperature or humidity exceeds those recommended by ROHM
   - [c] the Products are exposed to direct sunshine or condensation
   - [d] the Products are exposed to high Electrostatic

2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.

3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.

4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

Precaution for Foreign Exchange and Foreign Trade act

Since concerned goods might be fallen under listed items of export control prescribed by Foreign exchange and Foreign trade act, please consult with ROHM in case of export.

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